

2N6139 thru 2N6144 (SILICON)

2N6148 thru 2N6150



### SILICON BIDIRECTIONAL THYRISTORS

... designed primarily for full-wave ac control applications, such as light dimmers, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied anode voltage with positive or negative gate triggering.

- Economical for a Wide Range of Uses
- High Surge Current —  $I_{TSM} = 100$  Amp
- Low Forward "On" Voltage — 1.4 V typ @  $I_{TM} = 14$  A
- All Diffused and Passivated Junctions for Greater Stability
- Rugged Construction in Either 3 Lead, Stud or Isolated Stud Package
- Gate Triggering Guaranteed in Four Modes

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
*Repetitive Peak Off-State Voltage, Note 1 ( $T_J = -65$ to $+100^\circ\text{C}$ , $\frac{1}{2}$ Sine Wave 50 to 60 Hz, Gate Open)	$V_{DRM}$		Volts
*Peak Principle Voltage 2N6139, 2N6142, 2N6148 2N6140, 2N6143, 2N6149 2N6141, 2N6144, 2N6150		200 400 600	
*Peak Gate Voltage	$V_{GM}$	10	Volts
*On-State Current RMS ( $-65$ to $+75^\circ\text{C}$ ) (Full Cycle Sine Wave, 50 to 60 Hz) ( $+90^\circ\text{C}$ )	$I_T(\text{RMS})$	10 5.0	Amp
*Peak Surge Current (One Full Cycle, 60 Hz, $T_J = +75^\circ\text{C}$ , preceded and followed by 10 A current)	$I_{TSM}$	100	Amp
Circuit Fusing Considerations ( $T_J = -65$ to $+100^\circ\text{C}$ , $t = 1.0$ to 8.3 ms)	$I^2t$	40	$\text{A}^2\text{s}$
*Peak Gate Power ( $T_J = +75^\circ\text{C}$ , Pulse Width = 2.0 $\mu$ )	$P_{GM}$	20	Watts
*Average Gate Power ( $T_J = +75^\circ\text{C}$ , $t = 8.3$ ms)	$P_{G(\text{AV})}$	0.5	Watt
*Peak Gate Current	$I_{GM}$	2.0	Amp
*Operating Junction Temperature Range	$T_J$	-65 to +100	$^\circ\text{C}$
*Storage Temperature Range	$T_{stg}$	-65 to +150	$^\circ\text{C}$
*Stud Torque 2N6139 thru 2N6144	—	15	in. lb.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
*Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C}/\text{W}$
Thermal Resistance, Case to Ambient	$R_{\theta CA}$	50	$^\circ\text{C}/\text{W}$

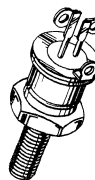
\*Indicates JEDEC Registered Data

### TRIACS (THYRISTORS) 10 AMPERES RMS



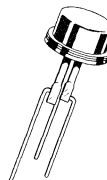
2N6139  
2N6140  
2N6141

CASE 86



2N6142  
2N6143  
2N6144

CASE 250



2N6148  
2N6149  
2N6150

CASE 87L

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
*Peak Blocking Current (Either Direction) Rated $V_{DRM}$ @ $T_J = 100^{\circ}\text{C}$ , Gate Open	$I_{DRM}$	—	—	2.0	mA
*On-State Voltage (Either Direction) $I_{TM} = 14$ A Peak, Pulse Width = 1.0 to 2.0 ms, Duty Cycle $\leq 2.0\%$	$V_{TM}$	—	1.4	1.8	Volts
Gate Trigger Current, Continuous dc Main Terminal Voltage = 12 Vdc, $R_L = 50$ Ohms, Minimum Gate Pulse Width = 2.0 $\mu\text{s}$	$I_{GT}$				mA
MT2 (+), G(+)	—	6.0	50		
MT2 (+), G(-)	—	6.0	75		
MT2 (-), G(-)	—	10	50		
MT2 (-), G(+)	—	25	75		
*MT2 (+), G(+); MT2 (-), G(-) $T_C = -65^{\circ}\text{C}$	—	—	—	125	
*MT2 (+), G(-); MT2 (-), G(+), $T_C = -65^{\circ}\text{C}$	—	—	—	150	
Gate Trigger Voltage, Continuous dc Main Terminal Voltage = 12 Vdc, $R_L = 50$ Ohms, Minimum Gate Pulse Width = 2.0 $\mu\text{s}$	$V_{GT}$				Volts
MT2 (+), G(+)	—	0.9	2.0		
MT2 (+), G(-)	—	0.9	2.5		
MT2 (-), G(-)	—	1.1	2.0		
MT2 (-), G(+)	—	1.4	2.5		
*MT2 (+), G(+); MT2 (-), G(-) $T_C = -65^{\circ}\text{C}$	—	—	—	2.5	
*MT2 (+), G(-); MT2 (-), G(+), $T_C = -65^{\circ}\text{C}$	—	—	—	3.0	
*Main Terminal Voltage = Rated $V_{DRM}$ , $R_L = 10$ k ohms, $T_J = 100^{\circ}\text{C}$		0.2	—	—	
Holding Current (Either Direction) Main Terminal Voltage = 12 Vdc, Gate Open, } $T_C = 25^{\circ}\text{C}$ Initiating Current = 300 mA } $T_C = -65^{\circ}\text{C}$	$I_H$	—	6.0	40	mA
		—	—	150*	
*Turn-On Time Main Terminal Voltage = Rated $V_{DRM}$ , $I_{TM} = 14$ A, Gate Source Voltage = 12 V, $R_S = 50$ Ohms, Rise Time = 0.1 $\mu\text{s}$ , Pulse Width = 2.0 $\mu\text{s}$	tgt	—	1.5	2.0	$\mu\text{s}$
Blocking Voltage Application Rate at Commutation, $f=60$ Hz, $T_C=75^{\circ}\text{C}$	dv/dt	—	5.0	—	V/ $\mu\text{s}$
On-State Conditions: $I_{TM} = 14$ A, Pulse Width = 4.0 ms, di/dt=5.3 A/ms					
Off-State Conditions: Main Terminal Voltage = Rated $V_{DRM}$ (200 $\mu\text{s}$ min), Gate Source Voltage = 0 V, $R_S = 100 \Omega$					

\*Indicates JEDEC Registered Data

**NOTES:**

1. Ratings apply for open gate conditions. Thyristor devices shall not be tested with a constant current source for blocking capability such that the voltage applied exceeds the rated blocking voltage.

Trigger devices are recommended for gating on Triacs.

**Triggers Provide:**

1. Consistent predictable turn-on points.
2. Simplified circuitry.
3. Fast turn-on time for cooler, more efficient and reliable operation.

Electrical Characteristics	For General Usage		For Lamp Dimmer
Symbol	MBS4991	MBS4992	MBS100
$V_S =$	6.0 –10 V	7.5–9.0 V	3.0–5.0 V
$I_S =$	350 $\mu\text{A}$ Max	120 $\mu\text{A}$ Max	100–400 $\mu\text{A}$
$V_{S1}-V_{S2} =$	0.5 V Max	0.2 V Max	0.35 V Max
Temperature Coefficient = 0.02%/ $^{\circ}\text{C}$ Typ			

See AN-526 for Theory and Characteristics of Silicon Bidirectional Switches.

FIGURE 1 – AVERAGE CURRENT DERATING

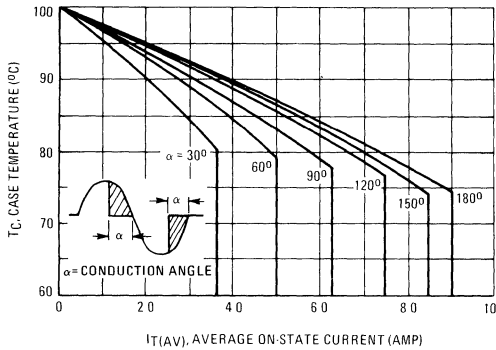


FIGURE 2 – RMS CURRENT DERATING

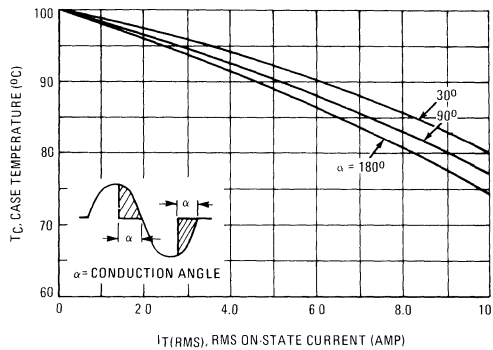


FIGURE 3 – POWER DISSIPATION

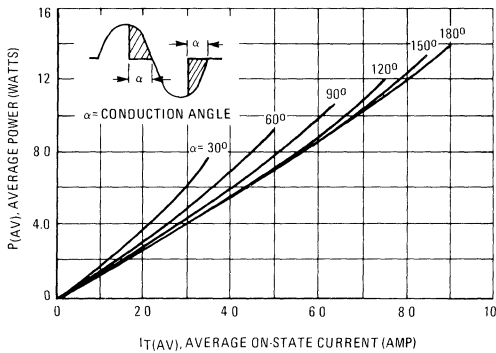


FIGURE 4 – POWER DISSIPATION

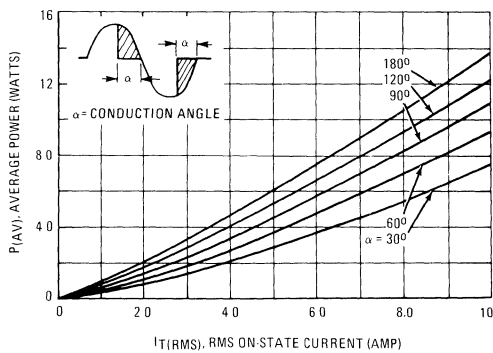


FIGURE 5 – TYPICAL GATE TRIGGER VOLTAGE

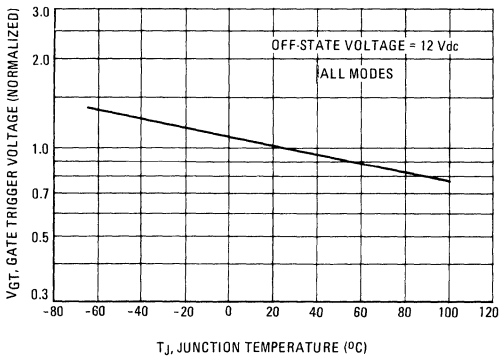


FIGURE 6 – TYPICAL GATE TRIGGER CURRENT

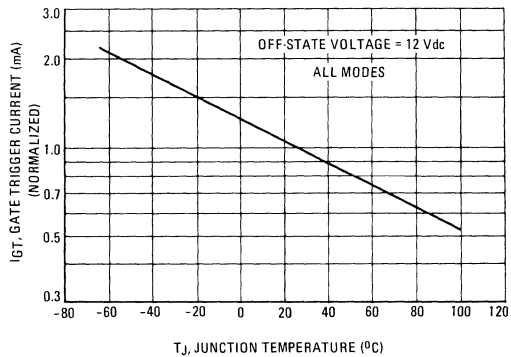


FIGURE 7 – MAXIMUM ON-STATE CHARACTERISTICS

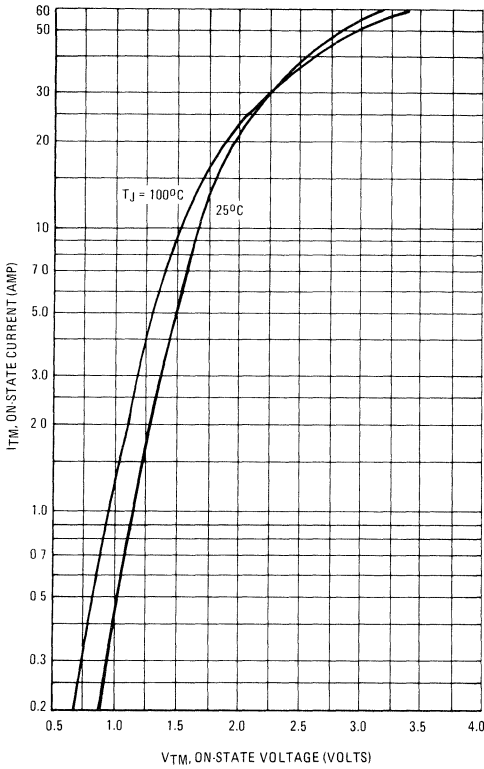


FIGURE 8 – TYPICAL HOLDING CURRENT

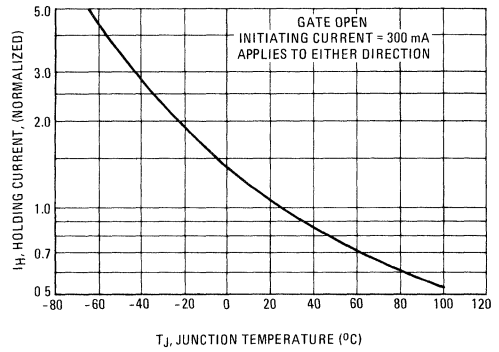


FIGURE 9 – MAXIMUM ALLOWABLE SURGE CURRENT

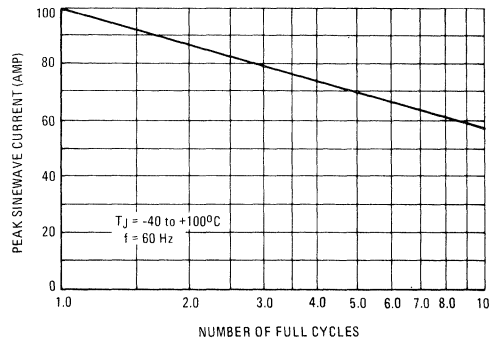
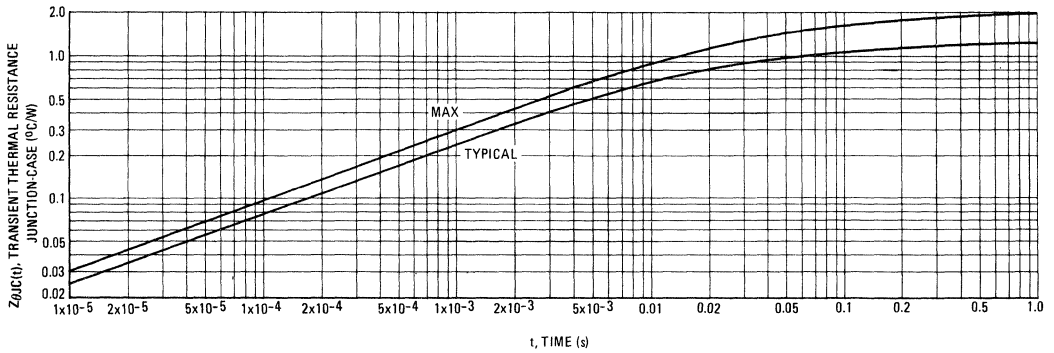
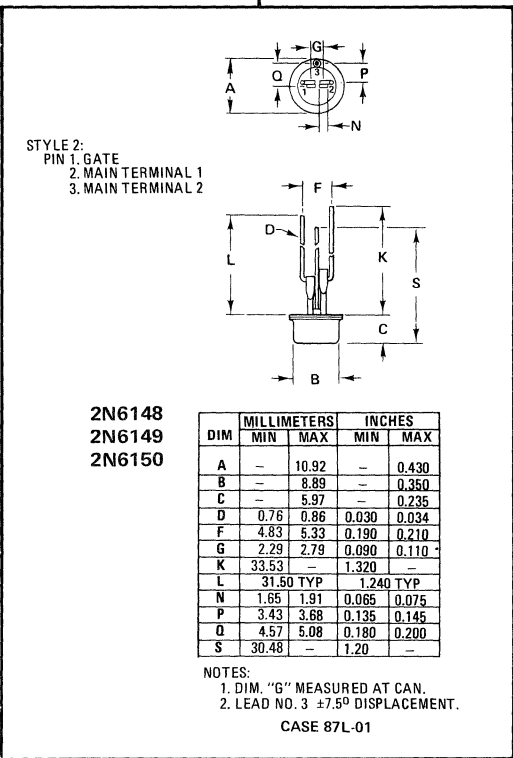
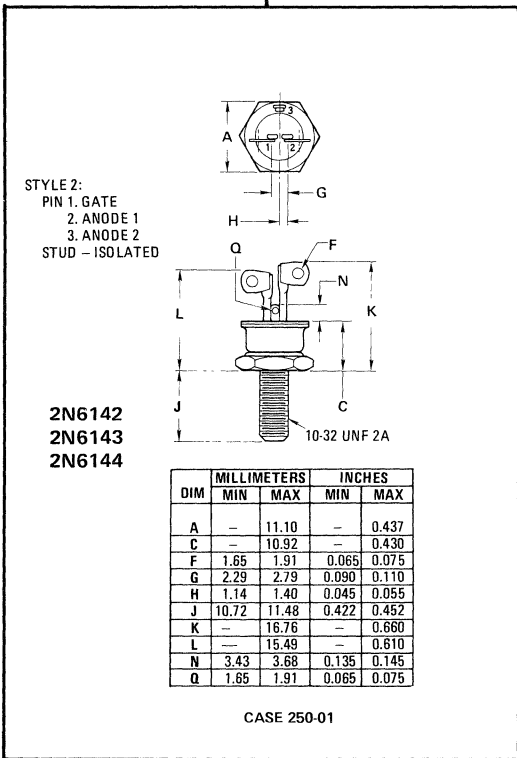
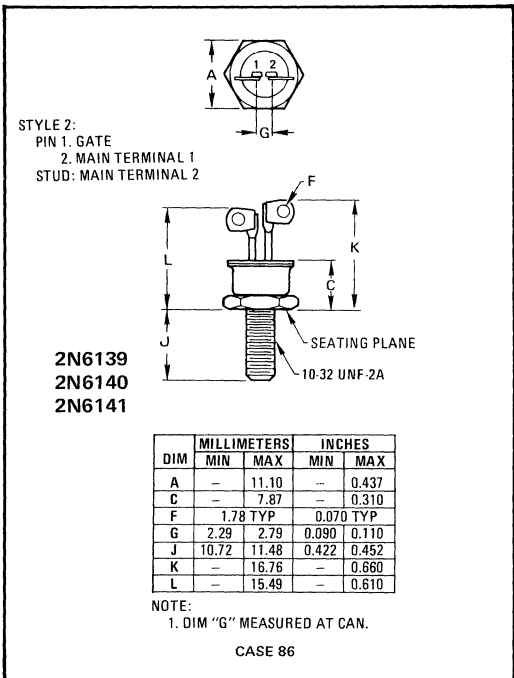


FIGURE 10 – THERMAL RESPONSE



2N6139 thru 2N6144, 2N6148 thru 2N6150 (continued)



2N6145 thru 2N6147 (SILICON)

For Specifications, See 2N5571 Data.